

TC51832P/SP/F-85, -10, -12

TC51832PL/SPL/FL-85, -10, -12

32,768 WORD x 8 BIT CMOS PSEUDO STATIC RAM

DESCRIPTION

The TC51832P Family is a 256K bit high speed CMOS Pseudo Static RAM organized as 32,768 words by 8 bits. The TC51832P Family utilizing one transistor dynamic memory cell with CMOS peripheral circuit provides large capacity, high speed and low power features. The feature includes single power supply of $5V \pm 10\%$. The OE/RFSH input allows two types of refresh operation - auto refresh and self refresh. The TC51832P Family also features static RAM like write function that the input data is written into the memory cell at the rising edge of R/W, thus being easy to interface with microprocessor. The TC51832P Family is pin-compatible with 256K bit CMOS static RAM and is moulded in a 28 pin standard 0.6 inch and 0.3 inch width plastic DIP and small-out-line plastic flat package.

FEATURES

- Organization: 256K bit(32,768 word x 8 bit)
- Fast Access Time and Low Power Dissipation

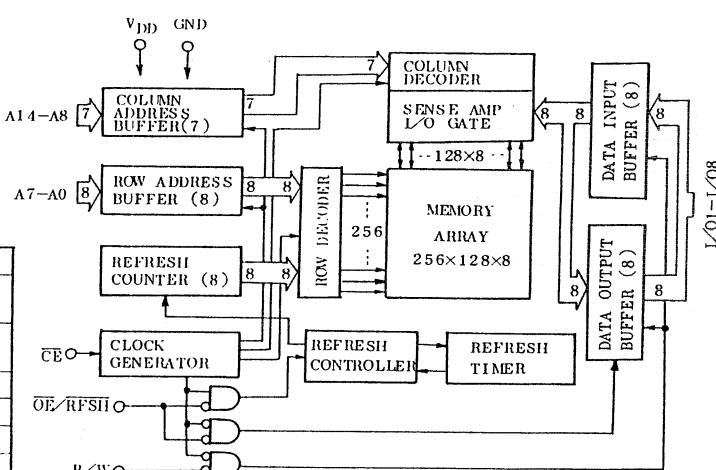
	TC51832P Family		
	-85	-10	-12
t_{CEA} \bar{CE} Access Time	85ns	100ns	120ns
t_{OEA} \bar{OE} Access Time	35ns	40ns	50ns
t_{RC} Cycle Time	135ns	160ns	190ns
P_D -Operating- Max.	303mW	248mW	220mW
Self Refresh Current	1mA/100 μ A (-L)		

- Self refresh is capable by internal timer.
 - All inputs and outputs: TTL compatible
 - 256 refresh cycle/4ms
 - Pin Compatible: 256K SRAM TC55257
 - Logic Compatible: SRAM R/W Pin
 - 28 pin Standard Plastic PKG
- P/PL : DIP28-P-600
TC51832 SP/SPL: DIP28-P-300
TC51832 F/FL : SCP28-P-450

- Single Power Supply: $5V \pm 10\%$
- Auto refresh is capable by internal counter.

PIN CONNECTION

(TOP VIEW)	
A14	1
A12	2
A7	3
A6	4
A5	5
A4	6
A3	7
A2	8
A1	9
A0	10
I/O1	11
I/O2	12
I/O3	13
GND	14
	15 I/O4
	16 I/O5
	17 I/O6
	18 I/O7
	19 I/O8
	20 CE
	21 A10
	22 $\bar{OE}/RFSH$
	23 A11
	24 A9
	25 A8
	26 A13
	27 I/O'W
	28 V _{DD}

BLOCK DIAGRAM**PIN NAMES**

A0 ~ A14	Address Inputs
R/W	Read/Write Control Input
$\bar{OE}/RFSH$	Output Enable/Refresh Input
\bar{CE}	Chip Enable Input
I/O1 ~ I/O8	Data Inputs/Outputs
V _{DD}	Power (+5V)
GND	Ground

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ABSOLUTE MAXIMUM RATINGS

SYMBOL	ITEM	RATING	UNITS	NOTE
V_{IN}	Input Voltage	-1.0 ~ 7.0	V	1
V_{OUT}	Output Voltage	-1.0 ~ 7.0	V	1
V_{DD}	Power Supply Voltage	-1.0 ~ 7.0	V	1
T_{OPR}	Operating Temperature	0 ~ 70	°C	1
T_{STG}	Storage Temperature	-55 ~ 150	°C	1
T_{SOLDER}	Soldering Temperature.Time	260 • 10	°C•sec	1
P_D	Power Dissipation	600	mW	1
I_{OUT}	Short Circuit Output Current	50	mA	1

DC RECOMMENDED OPERATING CONDITIONS (Ta=0 ~ 70°C)

SYMBOL	ITEM	MIN.	TYP.	MAX.	UNIT	NOTE
V_{DD}	Power Supply Voltage	4.5	5.0	5.5	V	2
V_{IH}	Input High Voltage	2.4	-	6.5	V	2
V_{IL}	Input Low Voltage	-1.0	-	0.8	V	2

DC ELECTRICAL CHARACTERISTICS ($V_{DD}=5V \pm 10\%$, Ta=0 ~ 70°C)

SYMBOL	PARAMETER	PERIOD	MIN.	MAX.	UNITS	NOTES
I_{DDO}	Operating Current (Average Power Supply Operating Current) \overline{CE} , Address Cycling: $t_{RC}=t_{RC\ MIN.}$	135ns	-	55	mA	3, 4
		160ns	-	45		
		190ns	-	40		
I_{DDS1}	Standby Current 1 $\overline{CE}=\overline{OE}/\overline{RFSH}=V_{IH}$	TC51832P/SP/F	-	2	mA	
		TC51832PL/SPL/FL	-	1		
I_{DDS2}	Standby Current 2 $\overline{CE}=\overline{OE}/\overline{RFSH}=V_{DD}-0.2V$	TC51832P/SP/F	-	1	mA	
		TC51832PL/SPL/FL	-	100		
I_{DDF}	Self Refresh Current $\overline{CE}=V_{DD}-0.2V$, $\overline{OE}/\overline{RFSH}=0.2V$	TC51832P/SP/F	-	1	mA	
		TC51832PL/SPL/FL	-	100		
$I_{I(L)}$	Input Leakage Current $0V \leq V_{IN} \leq V_{DD}$, All other inputs not under test=0V		-10	10	μA	
$I_{O(L)}$	Output Leakage Current Output Disable, $0V \leq V_{OUT} \leq V_{DD}$		-10	10	μA	
V_{OH}	Output High Level $I_{OUT}=-5mA$		2.4	-	V	
V_{OL}	Output Low Level $I_{OUT}=4.2mA$		-	0.4	V	

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ELECTRICAL CHARACTERISTICS AND RECOMMENDED AC OPERATING CONDITIONS

($V_{DD}=5V\pm10\%$, $T_a=0\sim70^\circ C$) (NOTES: 5, 6, 7, 8, 9)

SYMBOL	PARAMETER	-85		-10		-12		UNITS	NOTES
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
t_{RC}	Random Read or Write Cycle Time	135	-	160	-	190	-	ns	
t_{RMW}	Read Modify Write Cycle Time	200	-	240	-	280	-	ns	
t_{CE}	\overline{CE} Pulse Width	85	10,000	100	10,000	120	10,000	ns	
t_P	\overline{CE} Precharge Time	40	-	50	-	60	-	ns	
t_{CEA}	CE Access Time	-	85	-	100	-	120	ns	
t_{OEA}	\overline{OE} Access Time	-	35	-	40	-	50	ns	
t_{CLZ}	\overline{CE} to Output in Low-Z	10	-	10	-	10	-	ns	
t_{OLZ}	\overline{OE} to Output in Low-Z	0	-	0	-	0	-	ns	
t_{WLZ}	Output Active from End of Write Enable	0	-	0	-	0	-	ns	
t_{CHZ}	Chip Disable to Output in High-Z	0	25	0	30	0	35	ns	10
t_{OHZ}	\overline{OE} Disable to Output in High-Z	0	25	0	30	0	35	ns	10
t_{WHZ}	Write Enable to Output in High-Z	0	25	0	30	0	35	ns	10
t_{OHC}	\overline{OE} Hold Time Referenced to \overline{CE}	0	-	0	-	0	-	ns	
t_{OSC}	\overline{OE} Set-Up Time Referenced to \overline{CE}	10	-	10	-	10	-	ns	
t_{RCS}	Read Command Set-Up Time	0	-	0	-	0	-	ns	
t_{RCH}	Read Command Hold Time	0	-	0	-	0	-	ns	
t_{WP}	Write Pulse Width	60	-	70	-	85	-	ns	
t_{WCH}	Write Command Hold Time	60	-	70	-	85	-	ns	
t_{CWL}	Write Command to \overline{CE} Lead Time	60	-	70	-	85	-	ns	
t_{DSW}	Data Set-Up Time Referenced to R/W	35	-	40	-	50	-	ns	11
t_{DSC}	Data Set-Up Time Referenced to \overline{CE}	35	-	40	-	50	-	ns	11
t_{DHW}	Data Hold Time Referenced to R/W	0	-	0	-	0	-	ns	11
t_{DHC}	Data Hold Time Referenced to \overline{CE}	0	-	0	-	0	-	ns	11
t_{ASC}	Address Set-Up Time	0	-	0	-	0	-	ns	12
t_{AHC}	Address Hold Time	20	-	25	-	30	-	ns	12
t_{FC}	Auto Refresh Cycle Time	135	-	160	-	190	-	ns	
t_{RFD}	\overline{CE} to \overline{RFSH} Delay Time	40	-	50	-	60	-	ns	
t_{FAP}	\overline{RFSH} Pulse Width (Auto Refresh)	80	8,000	80	8,000	80	8,000	ns	13
t_{FP}	\overline{RFSH} Precharge Time	30	-	30	-	30	-	ns	13
t_{FCE}	\overline{RFSH} to \overline{CE} Active Delay Time	160	-	190	-	225	-	ns	13
t_{FAS}	\overline{RFSH} Pulse Width (Self Refresh)	8,000	-	8,000	-	8,000	-	ns	13
t_{FRS}	\overline{CE} Delay Time from \overline{RFSH} (Self Refresh)	160	-	190	-	225	-	ns	13

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(Continued)

SYMBOL	PARAMETER	-85		-10		-12		UNITS	NOTES
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
t_{FST}	RFSH Set-Up Time (Refresh Counter Test)	10	30	10	30	10	30	ns	
t_{FHT}	RFSH Hold Time (Refresh Counter Test)	65	8,000	65	8,000	65	8,000	ns	
t_{REF}	Refresh Period	-	4	-	4	-	4	ms	
t_T	Transition Time (Rise and Fall)	3	50	3	50	3	50	ns	

CAPACITANCE ($V_{DD}=5V$, $f=1MHz$, $T_a=25^\circ C$)

SYMBOL	PARAMETER	MIN.	MAX.	UNITS
C_{I1}	Input Capacitance ($A_0 \sim A_{14}$)	-	5	pF
C_{I2}	Input Capacitance (\overline{CE} , $\overline{OE}/\overline{RFSH}$, R/W)	-	7	pF
C_{IO}	Input/Output Capacitance ($I/01 \sim I/08$)	-	7	pF

NOTE) This parameter is periodically sampled and is not 100% tested.

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NOTES:

- 1) Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device.
- 2) All voltages are referenced to GND.
- 3) IDDO depends on cycle rate.
- 4) IDDO depends on output loading. Specified values are obtained with the output open.
- 5) An initial pause of 1ms with high \overline{CE} and high $\overline{OE}/\overline{RFSH}$ is required after power-up, before proper device operation is achieved.
- 6) AC measurements assume $t_T=5\text{ns}$.
- 7) $V_{IH}(\text{min.})$ and $V_{IL}(\text{max.})$ are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IH} and V_{IL} .
- 8) Measured with a load equivalent to 2 TTL loads and 100pF.
- 9) The $\overline{OE}/\overline{RFSH}$ input operates as the output enable input (\overline{OE}) and refresh control input (\overline{RFSH}) under the condition of that $\overline{CE}=V_{IL}$ and $\overline{CE}=V_{IH}$, respectively.
- 10) t_{CHZ} , t_{OHZ} , t_{WHZ} define the time at which the output achieves the open circuit condition and is not referenced to output voltage levels.
- 11) In write cycles, the input data is latched at the earlier of R/W or \overline{CE} rising edge. Therefore the input data must be valid during set-up time (t_{DSW} , t_{DSC}) and hold time (t_{DHW} , t_{DHC}).
- 12) All address inputs are latched at the falling edge of \overline{CE} . Therefore all the address inputs must be valid during t_{ASC} and t_{AHC} .
- 13) Two refresh operation - auto refresh and self refresh are defined by the $\overline{OE}/\overline{RFSH}$ pulse width under the condition of $\overline{CE}=V_{IH}$.

Auto refresh: $\overline{OE}/\overline{RFSH}$ pulse width $\leq t_{FAP}$ (max.)

Self refresh: $\overline{OE}/\overline{RFSH}$ pulse width $\geq t_{FAS}$ (min.)

The following timing parameter must be kept for device proper operation after refresh

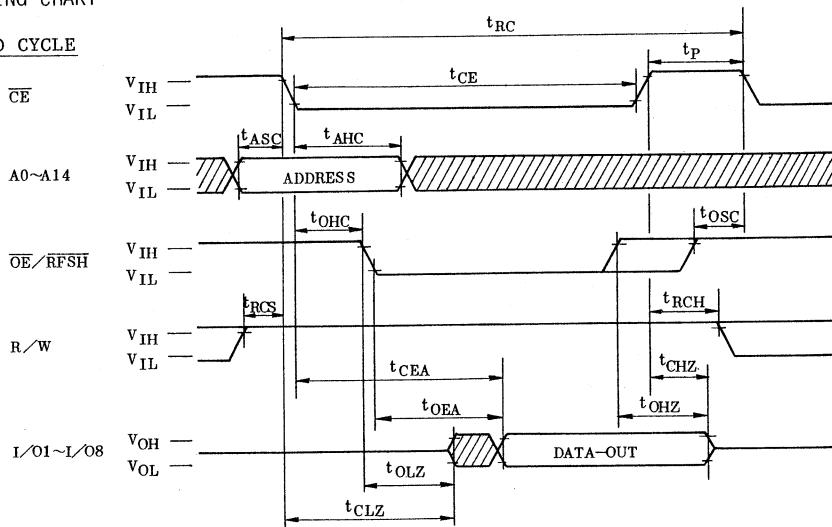
Auto refresh: t_{FCE}

Self refresh: t_{FRS}

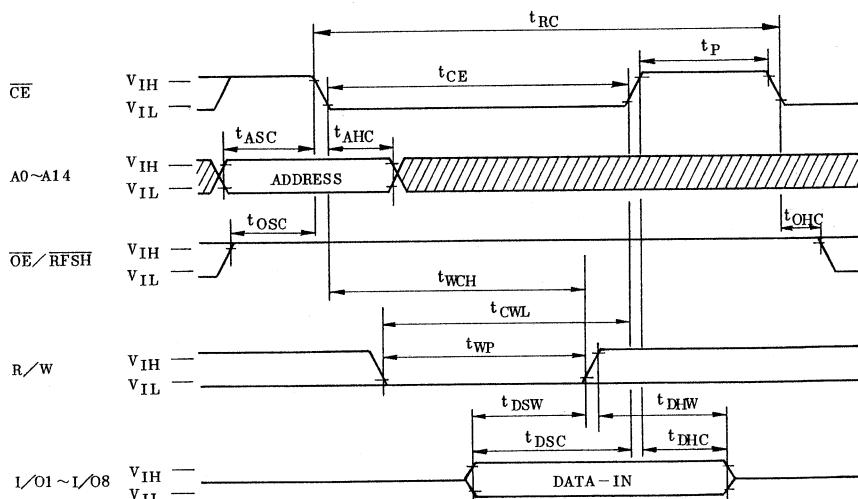
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TIMING CHART

READ CYCLE



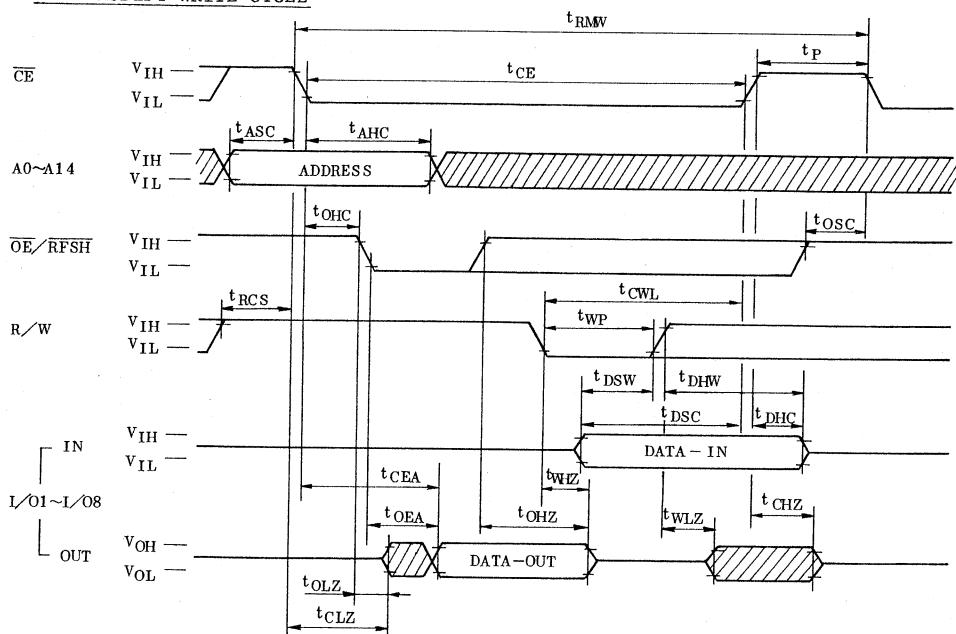
WRITE CYCLE



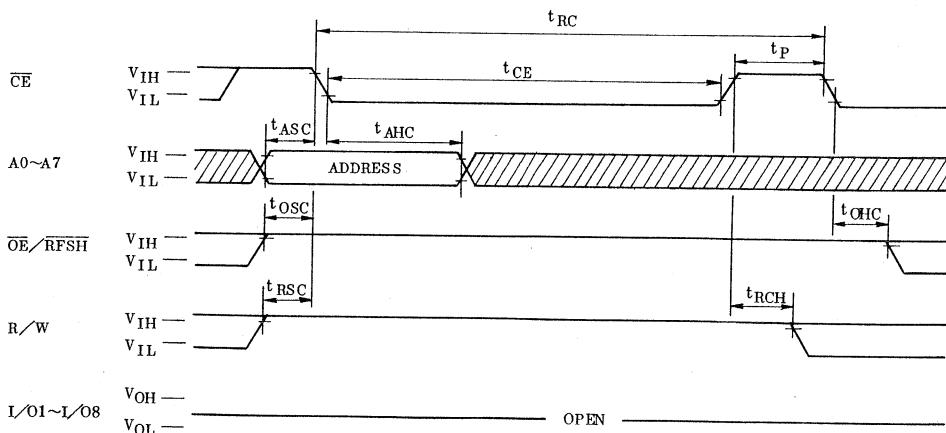
: Don't care

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READ MODIFY WRITE CYCLE



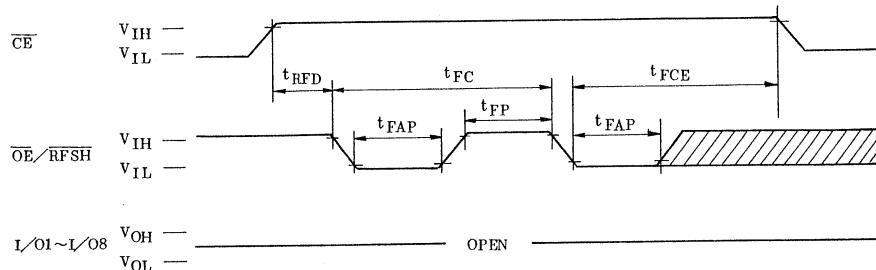
CE ONLY REFRESH CYCLE



: Don't care

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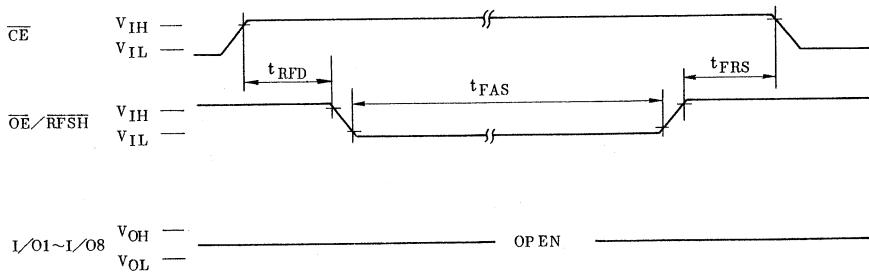
AUTO REFRESH CYCLE



Note) A0 ~ A14, R/W=Don't care

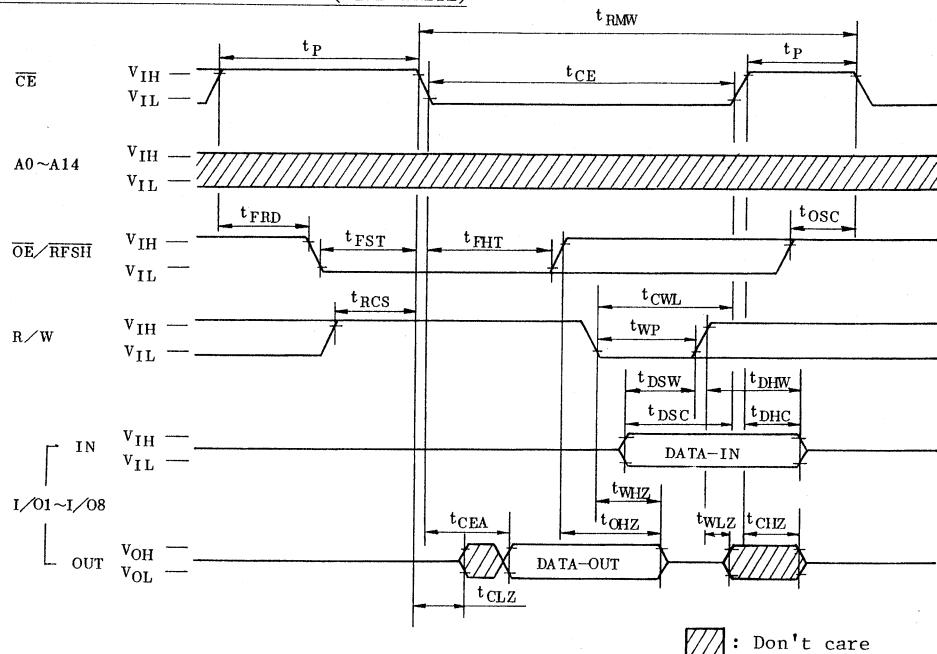
: Don't care

SELF REFRESH CYCLE



Note) A0 ~ A14, R/W=Don't care

REFRESH COUNTER TEST CYCLE (READ WRITE)



// : Don't care

REFRESH COUNTER TEST

The internal refresh operation of TC51832P family can be tested by REFRESH COUNTER TEST. This cycle performs READ/WRITE operation taking the internal counter address as row address and fixed zero as column address.

The test procedure is as follows.

- ① Write "0" into all the memory cells at normal write mode.
- ② Read "0" out and write "1" in each cell by performing REFRESH COUNTER TEST.
Repeat this operation 256 times.
- ③ Check "1" out of 256 bits at normal read mode, which was written at ②.
- ④ Read "1" out and write "0" in each cell by performing REFRESH COUNTER TEST.
Repeat this operation 256 times.
- ⑤ Check "0" out of 256 bits at normal read mode, which was written at ④.
- ⑥ Perform the above ① to ⑤ the complement data.

TOSHIBA

DATA BOOK

**MOS MEMORY
(VRAM, SRAM)**

1991

INTRODUCTION

We continually venture at the leading edge of technology so that we may develop and offer to you a diverse array of semiconductor memory products which may be used in many commercial and industrial applications. At this time, we offer three data books; "MOS-Memory Dynamic RAM and Module", "MOS-Memory Video RAM and Static RAM" and "MOS-Memory ROM".

Particularly, this data book is "MOS-Memory Video RAM and Static RAM" edition.

These data books represent our current culminations of electrical characteristics, timing waveforms and package data for our line of semiconductor memory products.

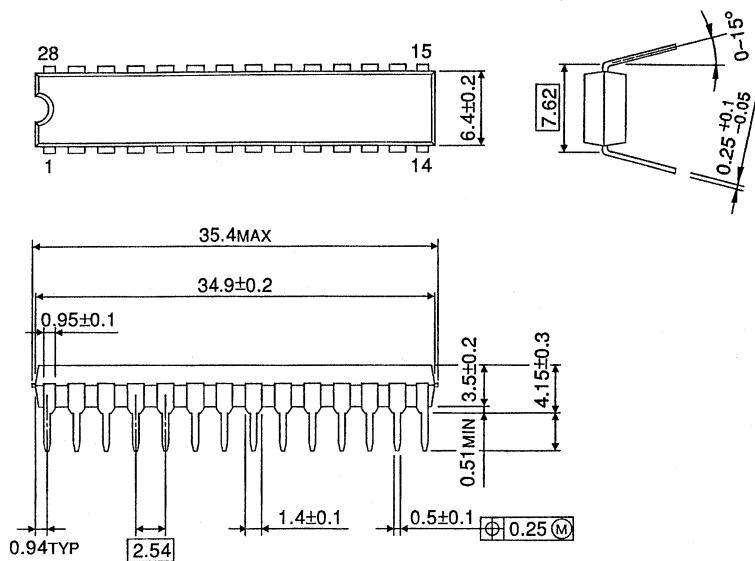
We hope this information will be very useful for you.

Nov. 1991

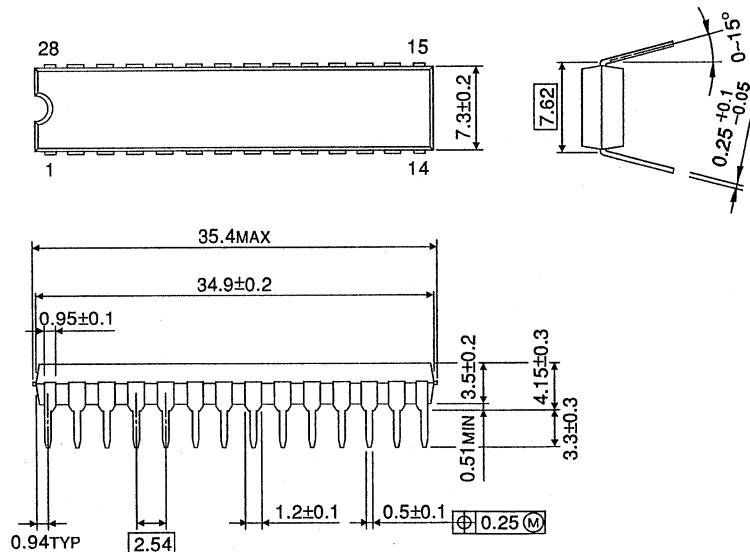
TOSHIBA CORPORATION
Semiconductor Group

Unit in mm

DIP28-P-300A

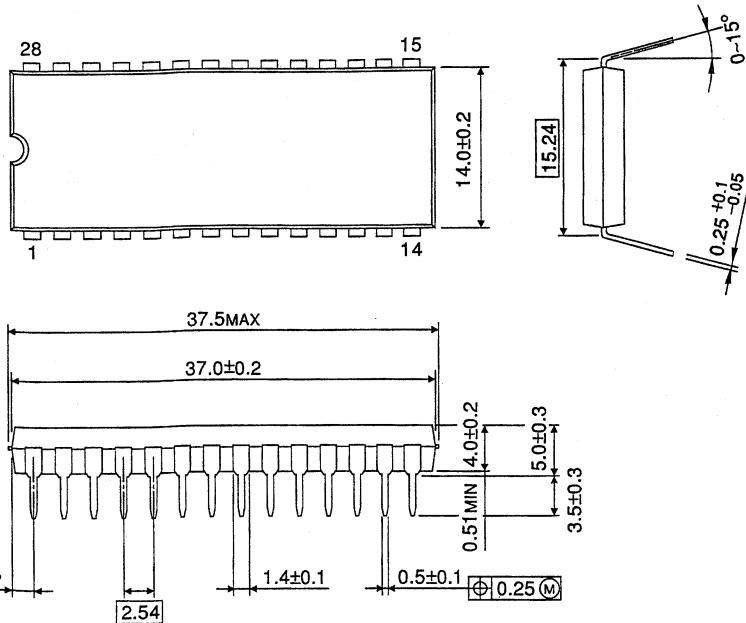


DIP28-P-300B

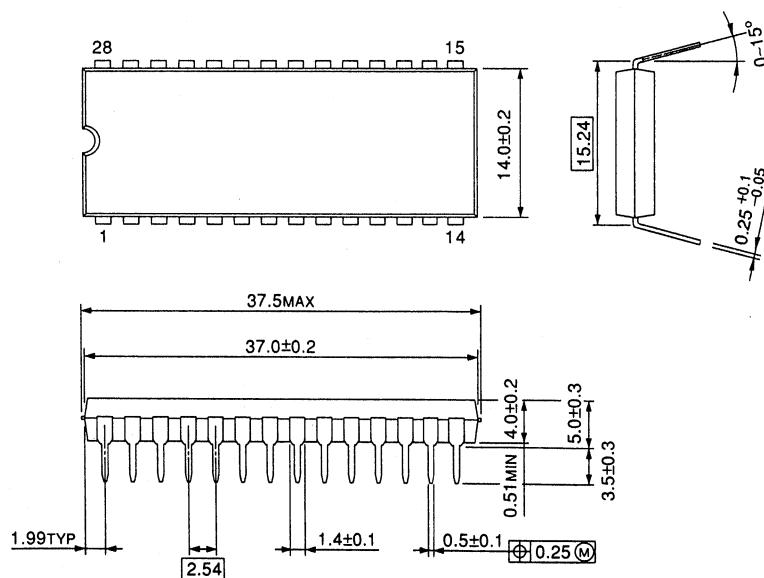


Unit in mm

DIP28-P-400A

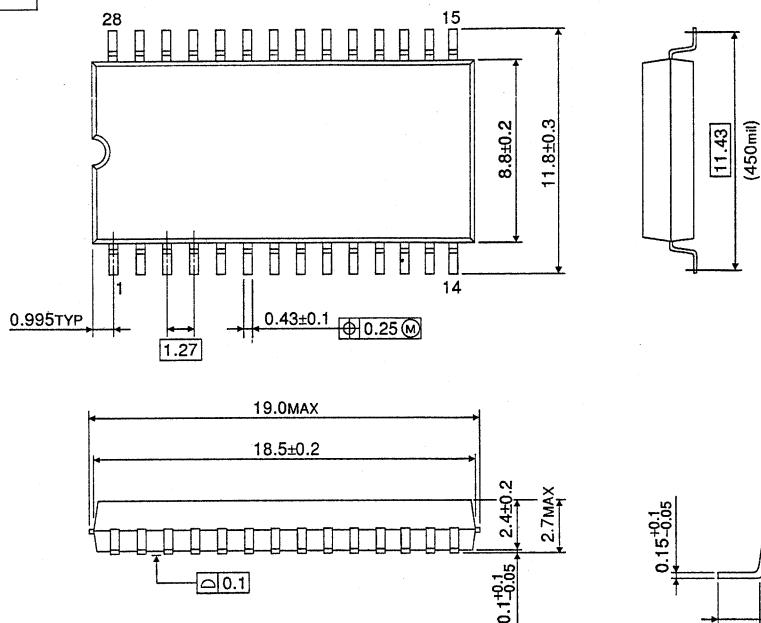


DIP28-P-600



Unit in mm

SOP28-P-450



SOP32-P-450

